



GL40N120A47P

Silicon N-Channel Power MOSFET

General Description:

GL40N120A47P, the silicon N-channel Enhanced VDMOSFET is obtained by the self-aligned planar Technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. The transistor can be used in various power switching circuit for system miniaturization and higher efficiency. The package form is TO-247PLUS, which accords with the RoHS standard.

Features:

- Fast Switching
- ESD Improved Capability
- Low Gate Charge
- Low Reverse transfer capacitances
- 100% Single Pulse avalanche energy Test

Applications:

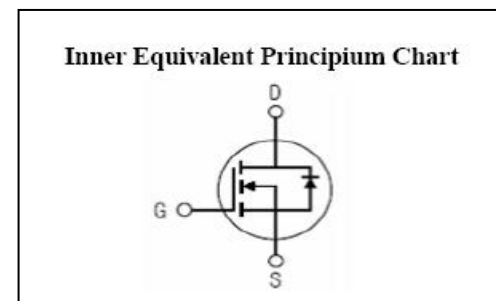
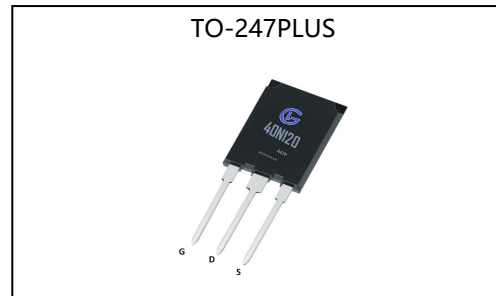
- Power switch circuit of PC POWER

Absolute (T_c=25°C unless otherwise specified):

Symbol	Parameter	Rating	Units
V _{DSS}	Drain-to-Source Voltage	1200	V
I _D	Continuous Drain Current	40	A
	Continuous Drain Current T _C =100 °C	28	A
I _{DM} ^{a1}	Pulsed Drain Current (Pulse Width Limited by T _{JM})	160	A
V _{GS}	Gate-to-Source Voltage	±30	V
E _{AS}	Single Pulse Avalanche Energy	4500	mJ
E _{Ar} ^{a1}	Avalanche Energy ,Repetitive	320	mJ
I _{AR} ^{a1}	Avalanche Current	40	A
dv/dt ^{a2}	Peak Diode Recovery dv/dt	5.0	V/ns
P _D	Power Dissipation	1040	W
	Derating Factor above 25°C	8.32	W/°C
T _J , T _{stg}	Operating Junction and Storage Temperature Range	150, -55 to 150	°C
T _L	Maximum Temperature for Soldering	300	°C

Caution Stresses greater than those in the "Absolute Maximum Ratings" may cause permanent damage to the device

V _{DSS} (T _C =150°C)	1200	V
I _D	40	A
P _D (T _C =25°C)	1040	W
R _{DS(ON)TYPE}	300	mΩ



Thermal Characteristics



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Symbol	Parameter	Rating	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.121	°C/ W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	40	°C/ W

Electrical Characteristics ($T_c = 25^\circ\text{C}$ unless otherwise specified) :

OFF Characteristics

Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
V_{DSS}	Drain to Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	1200	--	--	V
I_{DSS}	Drain to Source Leakage Current	$V_{DS}=1200V, V_{GS}=0V, T_a=25^\circ\text{C}$	--	--	10	μA
		$V_{DS}=960V, V_{GS}=0V, T_a=125^\circ\text{C}$	--	--	1000	
$I_{GSS(F)}$	Gate to Source Forward Leakage	$V_{GS}=+30V$	--	--	200	nA
$I_{GSS(R)}$	Gate to Source Reverse Leakage	$V_{GS}=-30V$	--	--	-200	nA

ON Characteristics

Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$R_{DS(ON)}$	Drain-to-Source On-Resistance	$V_{GS}=10V, I_D=20A$	--	300	400	m Ω
$V_{GS(TH)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	2.5	--	4.5	V
g_{fs}	Forward Trans conductance	$V_{DS}=20V, I_D=20A$	--	30	--	S
Pulse width < 380 μs ; duty cycle < 2%.						

Dynamic Characteristics

Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
C_{iss}	Input Capacitance	$V_{GS}=0V, V_{DS}=25V$ $f=1.0\text{MHz}$	--	16000	--	pF
C_{oss}	Output Capacitance		--	950	--	
C_{rss}	Reverse Transfer Capacitance		--	180	--	

Resistive Switching Characteristics

Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
$t_{d(ON)}$	Turn-on Delay Time	$I_D=20A, V_{DD}=600V$ $V_{GS}=10V, R_g=10\Omega$	--	70	--	ns
t_r	Rise Time		--	52	--	
$t_{d(OFF)}$	Turn-Off Delay Time		--	90	--	
t_f	Fall Time		--	55	--	
Q_g	Total Gate Charge	$I_D=20A, V_{DD}=600V$ $V_{GS}=10V$	--	310	--	nC
Q_{gs}	Gate to Source Charge		--	65	--	
Q_{gd}	Gate to Drain ("Miller") Charge		--	120	--	

Source-Drain Diode Characteristics

Symbol	Parameter	Test Conditions	Rating	Units
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			Min.	Typ.	Max.	
I_{SD}	Continuous Source Current (Body Diode)		--	--	40	A
I_{SM}	Maximum Pulsed Current (Body Diode)		--	--	160	A
V_{SD}	Diode Forward Voltage	$I_S=40A, V_{GS}=0V$	--	--	1.5	V
t_{rr}	Reverse Recovery Time	$I_S=40A, T_j=25^{\circ}C$	--	410	--	ns
Q_{rr}	Reverse Recovery Charge	$di_F/dt=100A/\mu s, V_{GS}=0V$	--	5.0	--	μC

a1: Repetitive rating; pulse width limited by maximum junction temperature

a2: $I_{SD}=40A, di/dt \leq 100A/\mu s, V_{DD} \leq BV_{DS}$, Start $T_j=25^{\circ}C$